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Amendments to the Claims

This listing of claims replaces all prior versions and listings of claims in the application.

Listing of Claims

1. (Previously Presented) A semiconductor device comprising:

a semiconductor layer formed on an insulating surface, and having at least a source region, a drain region, and a channel formation region interposed therebetween;

a first insulating film formed on said semiconductor layer;

at least one electrode formed on said first insulating film, and overlapping said channel formation region;

a source wiring formed on said first insulating film;

a second insulating film covering at least said at least one electrode and said source wiring; and

a gate wiring formed over said second insulating film, and connected to said at least one electrode.

- 2. (Original) A semiconductor device according to claim 1, wherein said gate wiring overlaps a portion of said semiconductor layer containing at least said channel formation region.
- 3. (Previously Presented) A semiconductor device according to claim 1, wherein said at least one electrode comprises a gate electrode.
- 4. (Previously Presented) A semiconductor device according to claim 1, wherein said at least one electrode and said source wiring comprise a same material.

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5. (Original) A semiconductor device according to claim 1, wherein a material of said gate wiring comprises one or a plurality of elements selected from the group consisting of poly-Si, W, WSi_x, Al, Cu, Ta, Cr and Mo.

- 6. (Original) A semiconductor device according to claim 1, wherein said first insulating film comprises a gate insulating film.
- 7. (Original) A semiconductor device according to claim 1, wherein said second insulating film further comprises a first insulating layer containing silicon as a main component and a second insulating layer containing an organic resin material.
- 8. (Previously Presented) A semiconductor device according to claim 1, wherein said semiconductor device is one selected from the group consisting of a personal computer, a video camera, a portable information terminal, a digital camera, a digital video disk player, a portable telephone, an electronic book, a projector, a head mounted type display, and an electric game appliance.
 - 9. (Previously Presented) A semiconductor device comprising:
- a semiconductor layer formed on an insulating surface, and having at least a source region, a drain region, and a channel formation region interposed therebetween;
 - a first insulating film formed on said semiconductor layer;
- at least one electrode formed on said first insulating film, and overlapping said channel formation region;
 - a source wiring formed on said first insulating film;
 - a second insulating film covering at least said at least one electrode and said source wiring;
- a gate wiring formed over said second insulating film, and connected to said at least one electrode;

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a connection electrode formed over said second insulating film, and connected to said source wiring and said semiconductor layer; and

a pixel electrode formed over said second insulating film, and electrically connected to said semiconductor layer.

- 10. (Original) A semiconductor device according to claim 9, wherein said pixel electrode overlaps said source wiring.
- 11. (Original) A semiconductor device according to claim 9, wherein said gate wiring overlaps a portion of said semiconductor layer containing at least said channel formation region.
- 12. (Previously Presented) A semiconductor device according to claim 9, wherein said at least one electrode comprises a gate electrode.
- 13. (Previously Presented) A semiconductor device according to claim 9, wherein said at least one electrode and said source wiring comprise a same material.
- 14. (Original) A semiconductor device according to claim 9, wherein said pixel electrode, said connection electrode and said gate wiring comprise a same material.
- 15. (Original) A semiconductor device according to claim 9, wherein a material of said gate wiring comprises one or a plurality of elements selected from the group consisting of poly-Si, W, WSi_x, Al, Cu, Ta, Cr and Mo.
- 16. (Original) A semiconductor device according to claim 9, wherein said first insulating film comprises a gate insulating film.

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17. (Original) A semiconductor device according to claim 9, wherein said second insulating film further comprises a first insulating layer containing silicon as a main component and a second insulating layer containing an organic resin material.

- 18. (Previously Presented) A semiconductor device according to claim 9, wherein one pixel including said pixel electrode forms a storage capacitor between said semiconductor layer connected to said pixel electrode and said at least one electrode connected to a gate wiring of an adjacent pixel, using said first insulating film as a dielectric.
- 19. (Original) A semiconductor device according to claim 9, wherein an impurity element for imparting a p-type conductivity is added to said semiconductor layer connected to said pixel electrode.
- 20. (Previously Presented) A semiconductor device according to claim 9, said semiconductor device is one selected from the group consisting of a personal computer, a video camera, a portable information terminal, a digital camera, a digital video disk player, a portable telephone, an electronic book, a projector, a head mounted type display, and an electric game appliance.
 - 21. (Previously Presented) A semiconductor device comprising:
- a semiconductor layer and at least one electrode including a gate electrode adjacent to said semiconductor layer with a first insulating film interposed therebetween;
 - a source wiring formed on said first insulating film;
 - a second insulating film covering at least said at least one electrode and said source wiring;
- a gate wiring formed over said second insulating film, and electrically connected to said at least one electrode; and
 - a pixel electrode electrically connected to said semiconductor layer,
 - wherein said pixel electrode is formed over said second insulating film.

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22. (Original) A semiconductor device according to claim 21, wherein said gate wiring overlaps a portion of said semiconductor layer containing at least said channel formation region.

- 23. (Previously Presented) A semiconductor device according to claim 21, wherein said at least one electrode and said source wiring comprise a same material.
- 24. (Original) A semiconductor device according to claim 21, wherein a material of said gate wiring comprises one or a plurality of elements selected from the group consisting of poly-Si, W, WSi_x, Al, Cu, Ta, Cr and Mo.
- 25. (Original) A semiconductor device according to claim 21, wherein said first insulating film comprises a gate insulating film.
- 26. (Original) A semiconductor device according to claim 21, wherein said second insulating film further comprises a first insulating layer containing silicon as a main component and a second insulating layer containing an organic resin material.
- 27. (Previously Presented) A semiconductor device according to claim 21, wherein said semiconductor device is one selected from the group consisting of a personal computer, a video camera, a portable information terminal, a digital camera, a digital video disk player, a portable telephone, an electronic book, a projector, a head mounted type display, and an electric game appliance.
- 28. (Previously Presented) A semiconductor device comprising a pair of substrates and a liquid crystal interposed therebetween, one of said pair of substrates having at least a pixel portion and a driver circuit, said pixel portion comprising:

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a semiconductor layer formed on an insulating surface, and having at least a source region, a drain region and a channel formation region interposed therebetween;

a first insulating film formed on said semiconductor layer;

at least one electrode formed on said first insulating film, and overlapping at least said channel formation region;

a source wiring formed on said first insulating film;

a second insulating film covering at least said at least one electrode and said source wiring;

a gate wiring formed over said second insulating film, and connected to said at least one electrode;

a connection electrode formed over said second insulating film, and connected to said source wiring and said semiconductor layer; and

a pixel electrode formed over said second insulating film, and electrically connected to said semiconductor layer, and

wherein the other one of said pair of substrates comprises a light-shielding film in which a red color filter and a blue color filter are laminated so as to overlap said semiconductor layer.

- 29. (Original) A semiconductor device according to claim 28, further comprising a common wiring on said second insulating film, wherein said pixel electrode and said common wiring are arranged so that an electric field substantially parallel to a surface of said substrate is generated.
- 30. (Original) A semiconductor device according to claim 28, said semiconductor device is a reflection-type liquid crystal display device in which said pixel electrode comprises a film containing Al or Ag or a lamination film thereof.
- 31. (Original) A semiconductor device according to claim 28, said semiconductor device is a transmission-type liquid crystal display device in which said pixel electrode comprises a transparent electrically conductive film.

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32. (Previously Presented) A semiconductor device according to claim 28, said semiconductor device is one selected from the group consisting of a personal computer, a video camera, a portable information terminal, a digital camera, a digital video disk player, a portable telephone, an electronic book, a projector, a head mounted type display, and an electric game appliance.

- 33. (Previously Presented) A semiconductor device comprising a pair of substrates and a liquid crystal interposed therebetween, one of said pair of substrates having at least a pixel portion and a driver circuit, said pixel portion comprising:
- a semiconductor layer formed on an insulating surface, and having at least a source region, a drain region and a channel formation region interposed therebetween;
 - a first insulating film formed on said semiconductor layer;
- at least one electrode formed on said first insulating film, and overlapping at least said channel formation region;
 - a source wiring formed on said first insulating film;
 - a second insulating film covering at least said at least one electrode and said source wiring;
- a gate wiring formed over said second insulating film, and connected to said at least one electrode; and
- a pixel electrode formed over said second insulating film, and electrically connected to said semiconductor layer.
- 34. (Original) A semiconductor device according to claim 33, further comprising a common wiring on said second insulating film, wherein said pixel electrode and said common wiring are arranged so that an electric field substantially parallel to a surface of said substrate is generated.

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35. (Original) A semiconductor device according to claim 33, said semiconductor device is a reflection-type liquid crystal display device in which said pixel electrode comprises a film containing Al or Ag or a lamination film thereof.

- 36. (Original) A semiconductor device according to claim 33, said semiconductor device is a transmission-type liquid crystal display device in which said pixel electrode comprises a transparent electrically conductive film.
- 37. (Previously Presented) A semiconductor device according to claim 33, said semiconductor device is one selected from the group consisting of a personal computer, a video camera, a portable information terminal, a digital camera, a digital video disk player, a portable telephone, an electronic book, a projector, a head mounted type display, and an electric game appliance.

38-44. (Canceled)

- 45. (Currently Amended) A semiconductor device comprising:
- a semiconductor layer formed over an insulating substrate; [[and]]
- at least one electrode adjacent to said semiconductor layer with a first insulating film interposed therebetween;
 - a source wiring formed on said first insulating film;
- a second insulating film covering at least said at least one electrode and said source wiring; and
- a gate wiring formed over said second insulating film, and electrically connected to said at least one electrode.

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46. (Previously Presented) A semiconductor device according to claim 45, wherein said gate wiring overlaps a portion of said semiconductor layer containing at least a channel formation region.

- 47. (Previously Presented) A semiconductor device according to claim 45, wherein said at least one electrode and said source wiring comprise a same material.
- 48. (Previously Presented) A semiconductor device according to claim 45, wherein a material of said gate wiring comprises one or a plurality of elements selected from the group consisting of poly-Si, W, WSi_x, Al, Cu, Ta, Cr and Mo.
- 49. (Previously Presented) A semiconductor device according to claim 45, wherein said first insulating film comprises a gate insulating film.
- 50. (Previously Presented) A semiconductor device according to claim 45, wherein said second insulating film further comprises a first insulating layer containing silicon as a main component and a second insulating layer containing an organic resin material.
- 51. (Previously Presented) A semiconductor device according to claim 45, wherein said semiconductor device is one selected from the group consisting of a personal computer, a video camera, a portable information terminal, a digital camera, a digital video disk player, a portable telephone, an electronic book, a projector, a head mounted type display, and an electric game appliance.